

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Chung-Chieh Fang	§	Docket No.: 24061.106 (TSMC2003.0551)
	§	
Serial No.: 10/809,985	§	Examiner: TBD
	§	
Filed: March 26, 2004	§	Art Unit: 3623
	§	
For: Semiconductor Manufacturing	§	Conf. No.: 9614
Capacity Features Exchange System	§	
	§	

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner of Patents
Attention: Office of Initial Patent Examination's Filing Receipt Corrections
PO Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Attached is a copy of the official filing receipt received from the United States Patent and Trademark Office in the above-identified patent application in which issuance of a corrected filing receipt is respectfully requested.

Applicants request correction of the spelling of the named inventor to read as follows:

Chung-Chieh Fang

Enclosed herewith is an executed Declaration, which lists the correct spelling of the inventor's name. Applicants respectfully request approval and issuance of a corrected filing receipt.

No fee is believed to be due. However, the Commissioner is hereby authorized to charge any fees or credit any overpayments associated with this communication to Deposit Account No. 08-1394.

Respectfully submitted,



David M. O'Dell
Registration No. 42,044

Date: September 15, 2006

HAYNES AND BOONE, LLP
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Telephone: 972/739-8626
Facsimile: 214/200-0853

PATENT / DOCKET NO.: 24061.106 / TSMC2003-0551
CUSTOMER NO. 42717

**INVENTOR'S DECLARATION FOR
PATENT APPLICATION**

As below named inventor, I hereby declare that:

Our residence, post office address and citizenship are as stated below next to our names;

I believe I are the original, first and sole joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled

SEMICONDUCTOR MANUFACTURING CAPACITY FEATURES EXCHANGE SYSTEM

the specification of which: (check one)

_____ is attached hereto.

X _____ was filed on March 26, 2004
under Attorney's Docket Number 24061.106 (TSMC2003-0551)
as Application Serial No. 10/809,985
and was amended on _____ (if applicable).

I hereby authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF INVENTOR: Chung-Chieh Fang

INVENTOR'S SIGNATURE: Chung-Chieh Fang

DATED: Sept. 14, 2006

RESIDENCE and POST OFFICE ADDRESS: 374 Taylor Ave. Apt.1 Moscow ID 83843, USA
CITIZENSHIP: Taiwan, R.O.C.

R-70653.1



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/809,985	03/26/2004	3623	990	24061.106 (TSMC2003.0551)	6	25	2

42717
HAYNES AND BOONE, LLP
901 MAIN STREET, SUITE 3100
DALLAS, TX 75202

CONFIRMATION NO. 9614
UPDATED FILING RECEIPT
OC000000013353393
OC000000013353393

Date Mailed: 07/27/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. **If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).**

Applicant(s)

chieh
Chung-Chien Fang, Hsin-Chu, TAIWAN;

RECEIVED

JUL 30 2004

Assignment For Published Patent Application

Taiwan Semiconductor Manufacturing Co., Ltd., Hsin-Chu, TAIWAN;

HAYNES & BOONE LLP

Domestic Priority data as claimed by applicant

Foreign Applications

if Required, Foreign Filing License Granted: 06/04/2004

Projected Publication Date: 09/29/2005

Non-Publication Request: No

Early Publication Request: No

Title

Semiconductor manufacturing capacity features exchange system

Preliminary Class

24061.106
3.26.05-DD to FF
5.26.05- awaiting OA
Docketed 7.30.04
cef
Dmo - mk - JRM

**LICENSE FOR FOREIGN FILING UNDER
Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

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NOT GRANTED

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